

RFM Integrated Device, Inc.

PRODUCT SPECIFICATION

Part Number: CDR6004

DR Filter, GNSS, 1475 MHz, BW 100, IL 2

Halogen Free RoHS Compliant Product

ELECTRICAL CHARACTERISTICS

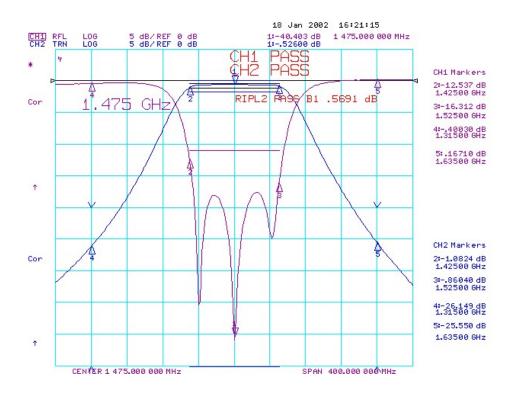
This filter satisfies Table 1 at Temperature Range : -30 to $+85^{\circ}$ C

CENTER FREQUENCY : fo=1475MHzPASSBAND WIDTH : $fo \pm 50$ MHz INPUT/OUTPUT IMPEDANCE : 50Ω Max. INPUT POWER : 1 W

TABLE 1

NO.	ITEM		SPECIFICATION
1	PASS BAND INSERTION LOSS		2.0 dB or less
2	PASS BAND RIPPLE		1.0 dB or less
3	PASS BAND RETURN LOSS		9.6 dB or more
4	STOP—BAND	at fo-160MHz	19dB or more
	ATTENUATION	at fo+160MHz	19dB or more
Item NO.4 specifies the absolute value of attenuation.			

ELECTRICAL RESPONSE



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4.RELIABILITY

4-1.STANDARD CONDITION

This standard shall satisfy the condition of Table 1 after the following test 4-2.

4-2.TEST METHOD

The filter shall withstand the following test condition.

4-2-1.Low temperature hold test :-40 $^{\circ}$ C

Unit shall be subjected to the above condition for 10 hours and then be left for more than 2 hours at room temperature.

4-2-2.High temperature hold test:+85°C

Unit shall be subjected to the above condition for 10 hours and then be left for more than 2 hours at room temperature.

4-2-3. Humidity soak test : $60\pm2^{\circ}$ C, $90\sim95\%$ relative humidity.

Unit shall be subjected to the above condition for 24 hours and then be left for more than 2 hours at room temperature.

4-2-4. Vibration test

The vibration of 5 G acceleration (Freq. 5 to 500Hz) and the sweep (0.1 octave per minute) are applied in three directions for 2 hours each.

4-2-5.Shock test

A half sine wave shock with a maximum acceleration of 30 G/11 msec. Is applied in six directions at right angles to each other by three times each.

4-2-6.Heat test

After the lead pins of the unit are soaked in solder bath at 270 $\pm 10^{\circ}$ C for 5 seconds and then be left for more than 1 hour at room temperature.

5.OTHER

In case of any problem regarding this specification, both customer and manufacturer shall discuss and solve it.

2.SOLDERING CONDITION (RECOMMENDED) SOLDER TEMPERATURE PROFILE (Reflow Soldering) 200 150 ± 10 130 ± 10 A/B A/B C C F

A : Preheating Times $\rightarrow 80 \sim 120$ Sec.B : Preheating Times $\rightarrow 40 \sim 80$ Sec.C : Soldering Time $\rightarrow 20 \sim 30$ Sec.D : Top Temp. $\rightarrow 220\pm10$ °CE : Max. $\rightarrow 10^{\circ}$ C / Sec.F : Max. $\rightarrow 8^{\circ}$ C / Sec.Composition of Cream Solder : 62Sn / 36Pb / 2AgSoldering with iron

Soldering condition : Soldering iron temperature 270 ± 10 °C Soldering time less than 3 seconds.

3. SHAPE AND DIMENSION

